

January 2012

FDP020N06B_F102

N-Channel PowerTrench[®] MOSFET 60V, 313A, $2m\Omega$

Features

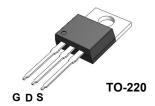
- $R_{DS(on)} = 1.65 \text{m}\Omega$ (Typ.) at $V_{GS} = 10 \text{V}$, $I_D = 100 \text{A}$
- Low FOM R_{DS(on)} *Q_G
- · Low Reverse-Recovery Charge, Q_{rr}
- · Soft Reverse-Recovery Body Diode
- · Enables High Efficiency in Synchronous Rectification
- · Fast Switching Speed
- · 100% UIL Tested
- · RoHS Compliant

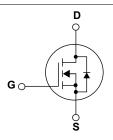
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Application

- · Synchronous Rectification for Server / Telecom PSU
- · Battery Charger and Battery Protection Circuit
- DC Motor Drives and Uninterruptible Power Supplies
- · Micro Solar Inverters





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage			60	V
V _{GSS}	Gate to Source Voltage	e to Source Voltage			V
		ilicon Limited)	313*		
I_D	Drain Current	Continuous (T _C = 100°C,	Silicon Limited)	221*	A
		Continuous (T _C = 25°C, P	ackage Limited)	120	
I _{DM}	Drain Current	Pulsed	(Note 1)	1252	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			1859	mJ
dv/dt	Peak Diode Recovery dv/d	It	(Note 3)	6.0	V/ns
D	Dawer Dissination	(T _C = 25°C)		333	W
P_{D}	Power Dissipation	Derate above 25°C		2.2	W/°C
T _J , T _{STG}	Operating and Storage Te	mperature Range		-55 to +175	°C
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

^{*}Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

Thermal Characteristics

Symbol	Parameter	Rating	Units		
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.45	°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	*C/VV		

Package Marking and Ordering Information

Device Marking	Device	Package	Description	Quantity
FDP020N06B	FDP020N06B_F102	TO-220	F102:Trimmed Leads	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C	-	0.03	-	V/°C
	Zero Gate Voltage Drain Current	V _{DS} = 48V, V _{GS} = 0V	-	-	1	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 48V, T_{C} = 150^{\circ}C$	-	-	500	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20V, V _{DS} = 0V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	3.3	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 100A$	-	1.65	2.0	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 10V, I_D = 100A$ (Note 4)) -	263	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 20V V 0V		-	16100	20930	pF
C _{oss}	Output Capacitance	$V_{DS} = 30V, V_{GS} = 0V$ f = 1MHz		-	3840	4992	pF
C _{rss}	Reverse Transfer Capacitance			-	127	-	pF
C _{oss(er)}	Energy Related Output Capacitance	V _{DS} = 30V, V _{GS} = 0V		-	5897	-	pF
Q _{g(tot)}	Total Gate Charge at 10V			-	206	268	nC
Q _{gs}	Gate to Source Gate Charge	V _{DS} = 30V, I _D = 100A		-	87	-	nC
Q _{gs2}	Gate to Threshold to Plateau	V _{GS} = 10V		-	36	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(N	lote 4, 5)	-	34	-	nC
ESR	Equivalent Series Resistance(G-S)	Drain Open, f = 1MHZ		-	0.9	-	Ω

Switching Characteristics

	•						
t _{d(on)}	Turn-On Delay Time			-	74	158	ns
t _r	Turn-On Rise Time	V _{DD} = 30V, I _D = 100A		-	62	134	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 4.7\Omega$		-	112	234	ns
t _f	Turn-Off Fall Time		(Note 4, 5)	-	42	94	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	313*	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	1252	Α
V_{SD}	Drain to Source Diode Forward Voltage V _{GS} = 0V, I _{SD} = 100A		-	-	1.25	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, V _{DD} = 30V, I _{SD} = 100A	-	106	-	ns
Q _{rr}	Reverse Recovery Charge $dI_F/dt = 100A/\mu s$ (Note 4)		-	194	-	nC

- $\begin{tabular}{ll} \textbf{Notes:} \\ 1. & \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature} \\ 2. & \textbf{Starting T}_J = 25^{\circ}\text{C, L} = 3\text{mH, I}_{AS} = 35.2\text{A} \\ 3. & \textbf{I}_{SD} \leq 100\text{A, di/dt} \leq 200\text{A/µs, V}_{DD} \leq \text{BV}_{DSS}, \textbf{Starting T}_J = 25^{\circ}\text{C} \\ 4. & \textbf{Pulse Test: Pulse width} \leq 300\text{µs, Duty Cycle} \leq 2\% \\ 5. & \textbf{Essentially Independent of Operating Temperature Typical Characteristics} \\ \end{tabular}$

Typical Performance Characteristics

Figure 1. On-Region Characteristics

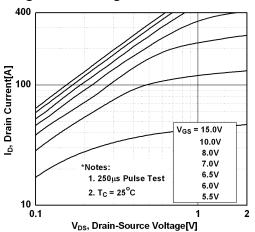


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

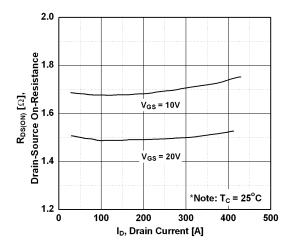


Figure 5. Capacitance Characteristics

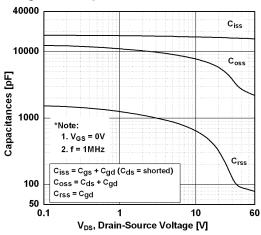


Figure 2. Transfer Characteristics

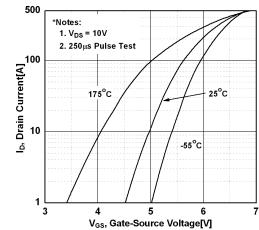


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

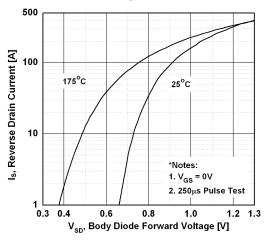
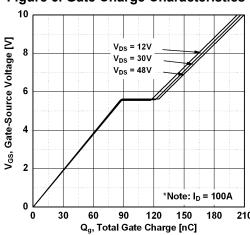


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

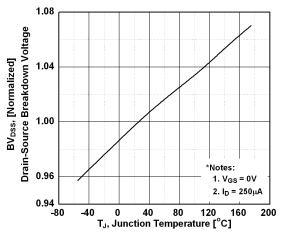


Figure 8. On-Resistance Varition vs. Temperature

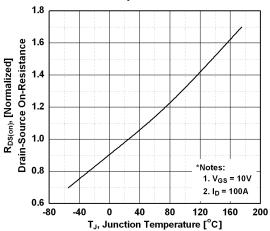


Figure 9. Maximum Safe Operating Area

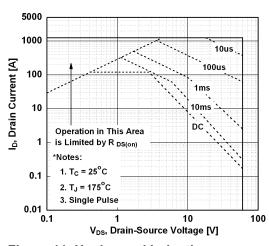


Figure 10. Maximum Drain Current vs. Case Temperature

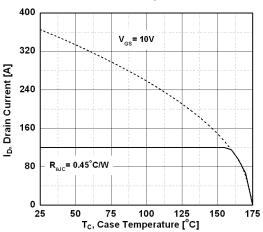


Figure 11. Unclamped Inductive Switching Capability

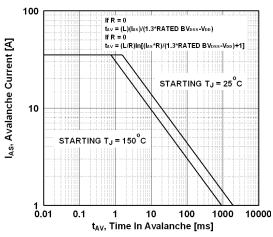
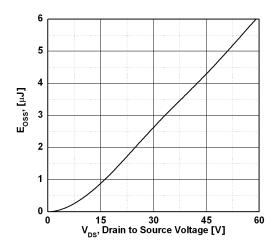
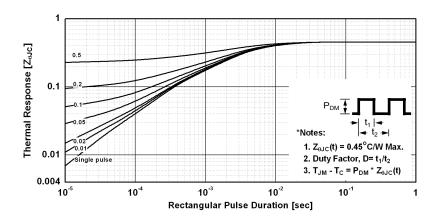


Figure 12. Eoss vs. Drain to Source Voltage

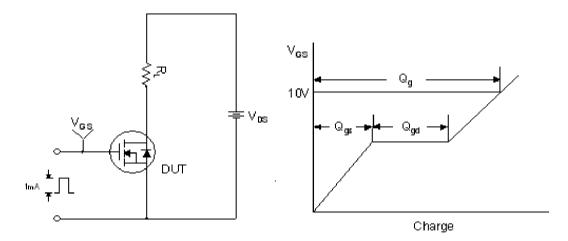


Typical Performance Characteristics (Continued)

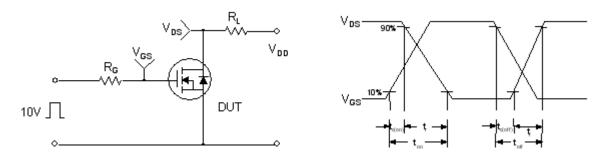




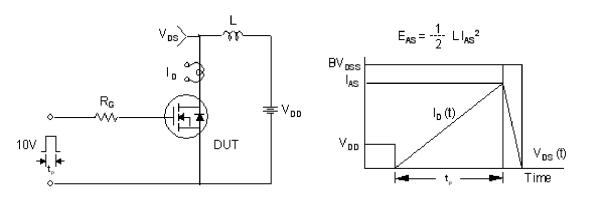
Gate Charge Test Circuit & Waveform



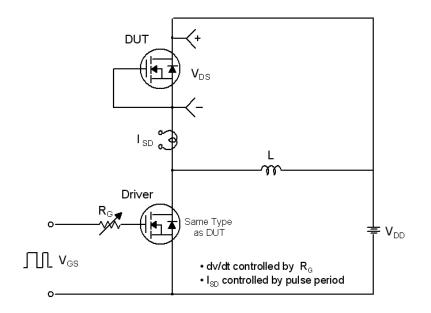
Resistive Switching Test Circuit & Waveforms

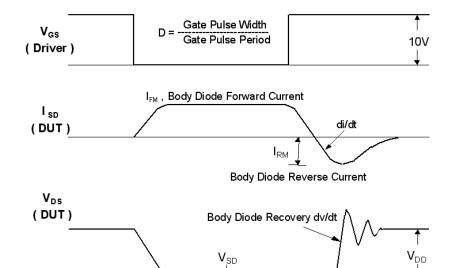


Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms

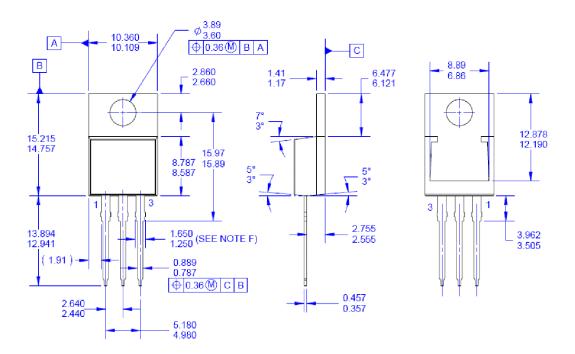


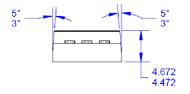


Body Diode Forward Voltage Drop

Physical Dimensions

TO-220T03





NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AB

- VARIATION AB
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
 D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 E. THIS PACKAGE IS FSZZ INTERNAL PRODUCTION AND INTENDED FOR DELTA CUSTOMER ONLY.
 F. MAX WIDTH FOR F102 DEVICE = 1.35mm.
 G. DRAWING FILE NAME: TO220T03REV3

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